



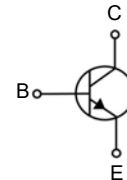
## Features

- Collector Current:  $I_C=0.6A$
- Power Dissipation of 300mw

1. BASE
2. EMITTER
3. COLLECTOR



SOT-523



## Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
HMMBT5551T	SOT-523	G1	3000

## Maxmim Ratings (Ta=25 unless otherwise noted)

Parameter	Symbol	Limit	Unit
Collector-Base Voltage	$V_{CBO}$	180	V
Collector-Emitter Voltage	$V_{CEO}$	160	V
Emitter-Base Voltage	$V_{EBO}$	6	V
Collector Current	$I_C$	600	mA
Collector Power Dissipation	$P_C$	300	mW
Thermal Resistance From Junction To Ambient	$R_{\theta JA}$	416	$^{\circ}C/W$
Junction Temperature	$T_J$	150	$^{\circ}C$
Storage Temperature	$T_{stg}$	-55~+150	$^{\circ}C$

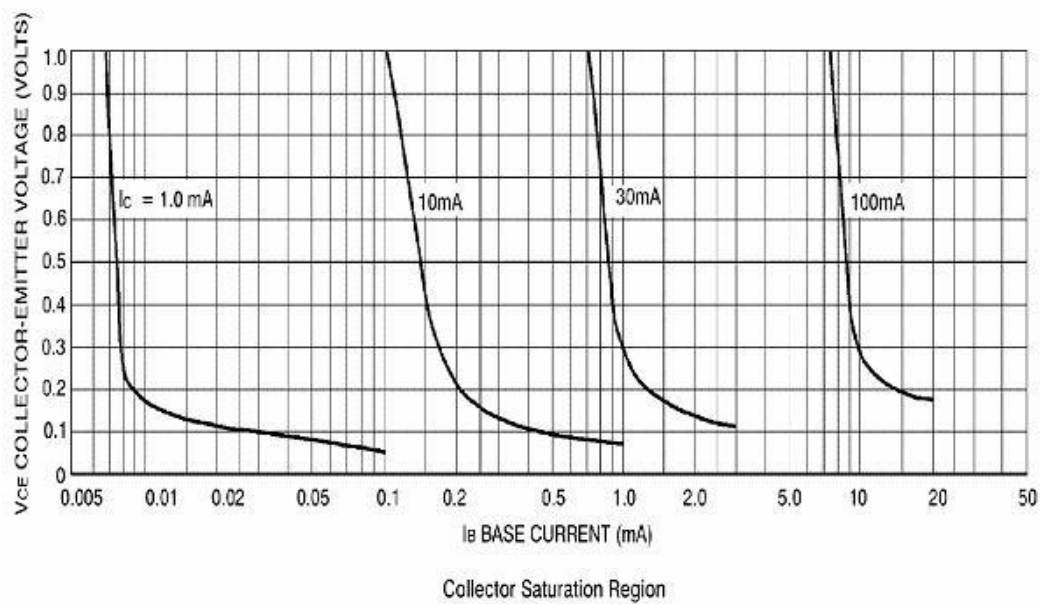
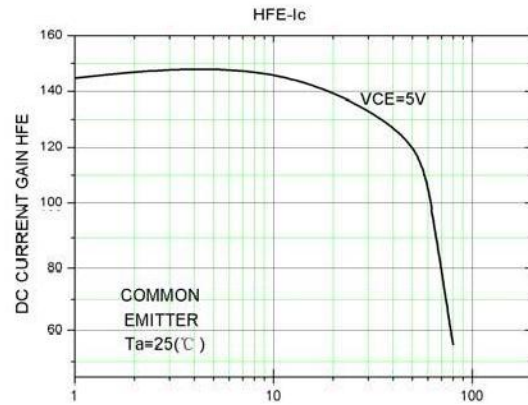
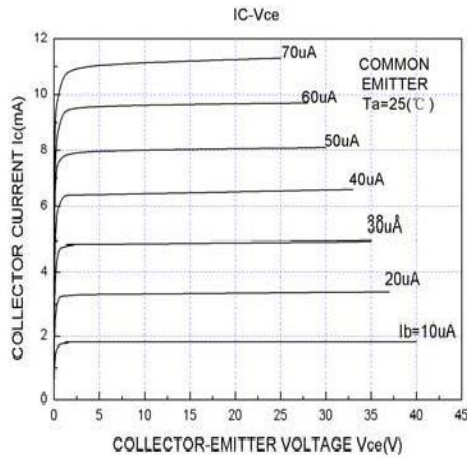
## Electrcal Charcteristics (Ta=25 unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Collector-base breakdown voltage	$V_{(BR)CBO}$	$I_C=100\mu A, I_E=0$	180			V
Collector-emitter breakdown voltage	$V_{(BR)CEO}^*$	$I_C=1mA, I_B=0$	160			V
Emitter-base breakdown voltage	$V_{(BR)EBO}$	$I_E=10\mu A, I_C=0$	6			V
Collector cut-off current	$I_{CBO}$	$V_{CB}=120V, I_E=0$			50	nA
Emitter cut-off current	$I_{EBO}$	$V_{EB}=4V, I_C=0$			50	nA
DC current gain	$h_{FE(1)}^*$	$V_{CE}=5V, I_C=1mA$	80			
	$h_{FE(2)}^*$	$V_{CE}=5V, I_C=10mA$	100		300	
	$h_{FE(3)}^*$	$V_{CE}=5V, I_C=50mA$	50			
Collector-emitter saturation voltage	$V_{CE(sat)1}^*$	$I_C=10mA, I_B=1mA$			0.15	V
	$V_{CE(sat)2}^*$	$I_C=50mA, I_B=5mA$			0.2	V
Base-emitter saturation voltage	$V_{BE(sat)1}^*$	$I_C=10mA, I_B=1mA$			1	V
	$V_{BE(sat)2}^*$	$I_C=50mA, I_B=5mA$			1	V
Transition frequency	$f_T$	$V_{CE}=10V, I_C=10mA, f=100MHz$	100		300	MHz
Collector output capacitance	$C_{ob}$	$V_{CB}=10V, I_E=0, f=1MHz$			6	pF

\*Pulse test: pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2.0\%$ .

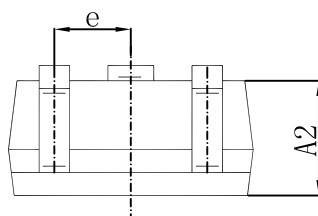
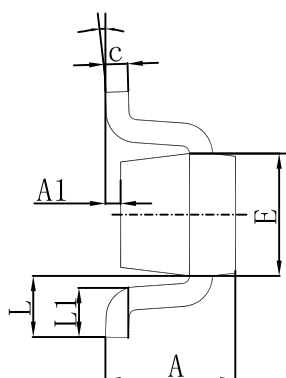
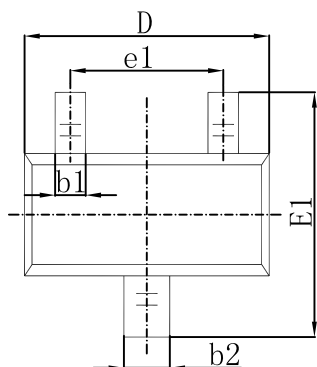


## Typical Characteristics



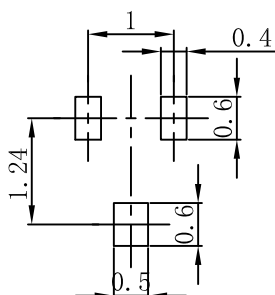


## SOT-523 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700	0.900	0.028	0.035
A1	0.000	0.100	0.000	0.004
A2	0.700	0.800	0.028	0.031
b1	0.150	0.250	0.006	0.010
b2	0.250	0.350	0.010	0.014
c	0.100	0.200	0.004	0.008
D	1.500	1.700	0.059	0.067
E	0.700	0.900	0.028	0.035
E1	1.450	1.750	0.057	0.069
e	0.500 TYP.		0.020 TYP.	
e1	0.900	1.100	0.035	0.043
L	0.400 REF.		0.016 REF.	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

## SOT-523 Suggested Pad Layout



- Note:
1. Controlling dimension: in millimeters.
  2. General tolerance:  $\pm 0.05\text{mm}$ .
  3. The pad layout is for reference purposes only.



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